AC Thyristor power switch Rev. 3 — 13 July 2010

Product data sheet

#### **Product profile** 1.

### **1.1 General description**

AC Thyristor power switch in a SOT54 plastic package with self-protective capabilities against low and high energy transients

### **1.2 Features and benefits**

- Exclusive negative gate triggering
- Full cycle AC conduction
- Remote gate separates the gate driver from the effects of the load current
- Safe clamping of low energy over-voltage transients
- Self-protective turn-on during high energy voltage transients
- Very high noise immunity

Pump motor circuits

### 1.3 Applications

- Fan motor circuits
- Lower-power highly inductive, resistive and safety loads

### **1.4 Quick reference data**

Table 1.	Quick reference da	ata				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage		-	-	600	V
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 100 mA; LD+ G-; T <sub>j</sub> = 25 °C; see <u>Figure 6</u>	1	-	10	mA
		V <sub>D</sub> = 12 V; I <sub>T</sub> = 100 mA; LD- G-; T <sub>j</sub> = 25 °C	1	-	10	mA
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>lead</sub> ≤ 71 °C; see <u>Figure 2</u>	-	-	0.8	A
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; $T_j$ = 125 °C; gate open circuit; see <u>Figure 10</u>	1000	-	-	V/µs
V <sub>CL</sub>	clamping voltage	I <sub>CL</sub> = 100 μA; t <sub>p</sub> = 1 ms; T <sub>j</sub> ≤ 125 °C; see <u>Figure 13</u>	650	-	-	V
V <sub>PP</sub>	peak pulse voltage	T <sub>j</sub> = 25 °C; non-repetitive, off-state; see <u>Figure 1</u>	-	-	2	kV
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.1 A; see <u>Figure 9</u>	-	-	1.3	V



# 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	CM	common		
2	G	gate		
3 LD load		G		
			SOT54 (TO-92)	

# 3. Ordering information

Table 3.	3. Ordering information			
Type number		Package		
		Name	Description	Version
ACT108-6	00E	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54

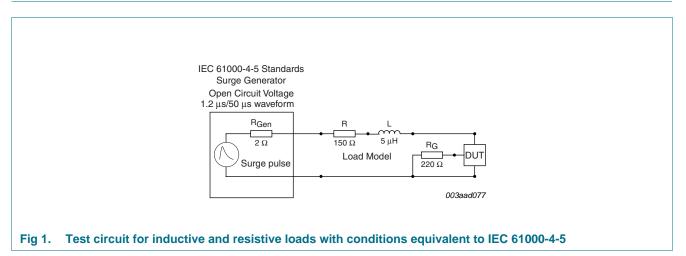
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### 4. Limiting values

#### Table 4. Limiting values

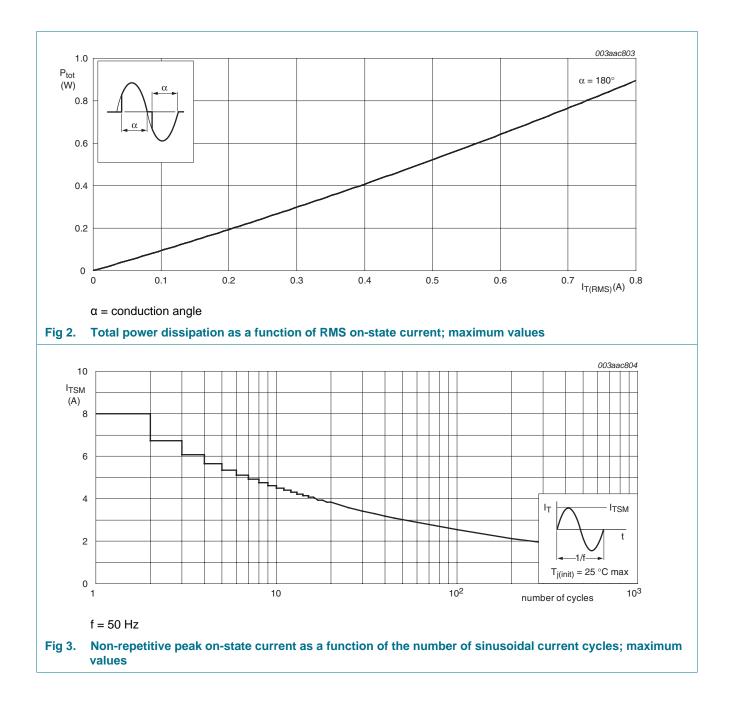
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage		-	600	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>lead</sub> ≤ 71 °C; see <u>Figure 2</u>	-	0.8	А
I <sub>TSM</sub>	non-repetitive peak on-state current	full sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 16.7 ms	-	8.8	А
		full sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 20 \text{ ms}$ ; see Figure 3; see Figure 4	-	8	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine-wave pulse	-	0.32	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	$I_T$ = 1 A; $I_G$ = 20 mA; $dI_G/dt$ = 0.2 A/µs	-	100	A/µs
I <sub>GM</sub>	peak gate current	t = 20 µs	-	1	А
V <sub>GM</sub>	peak gate voltage	positive applied gate voltage	-	15	V
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C
V <sub>PP</sub>	peak pulse voltage	T <sub>j</sub> = 25 °C; non-repetitive, off-state; see <u>Figure 1</u>	-	2	kV



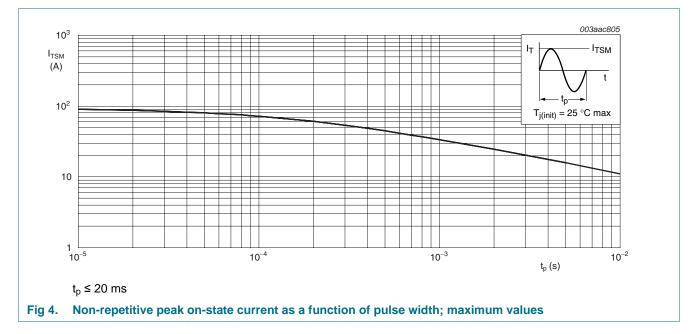
# ACT108-600E

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# ACT108-600E

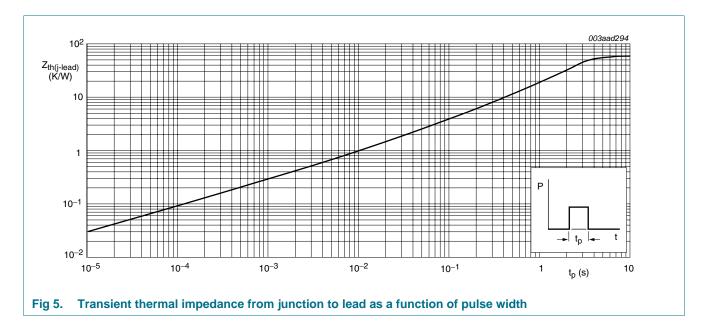
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### 5. Thermal characteristics

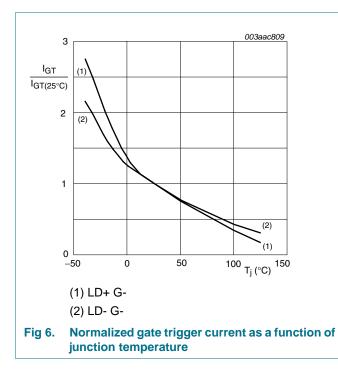
#### Table 5.Thermal characteristics

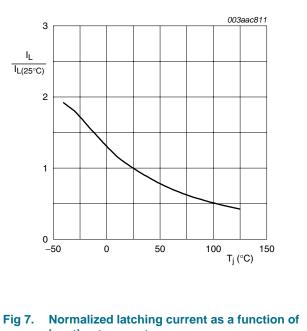
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	full cycle with heatsink compound; see <u>Figure 5</u>	-	-	60	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	full cycle; printed-circuit board mounted; lead length 4 mm	-	150	-	K/W



#### **Characteristics** 6.

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 100 mA; LD+ G-; T <sub>j</sub> = 25 °C; see <u>Figure 6</u>	1	-	10	mA
		$V_D$ = 12 V; I <sub>T</sub> = 100 mA; LD- G-; T <sub>j</sub> = 25 °C	1	-	10	mA
IL	latching current	V <sub>D</sub> = 12 V; I <sub>G</sub> = 12 mA; T <sub>j</sub> = 25 °C; see <u>Figure 7</u>	-	-	30	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; see <u>Figure 8</u>	-	9	25	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.1 A; see <u>Figure 9</u>	-	-	1.3	V
V <sub>GT</sub>	gate trigger voltage	$V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ T}_j \le 125 \text{ °C}$	0.15	-	-	V
		$V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ T}_j = 25 \text{ °C}$	-	-	1	V
I <sub>D</sub>	off-state current	$V_{D} = 600 \text{ V}; \text{ T}_{j} \le 125 \text{ °C}$	-	-	0.2	mA
		$V_{D} = 600 \text{ V}; \text{ T}_{j} \le 25 \text{ °C}$	-	-	2	μA
dV <sub>D</sub> /dt	rate of rise of off-state voltage	V <sub>DM</sub> = 402 V; T <sub>j</sub> = 125 °C; gate open circuit; see <u>Figure 10</u>	1000	-	-	V/µs
dl <sub>com</sub> /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 1 \text{ A};$ $dV_{com}/dt = 15 \text{ V}/\mu s;$ gate open circuit; see <u>Figure 11</u> ; see <u>Figure 12</u>	0.3	-	-	A/ms
V <sub>CL</sub>	clamping voltage	I <sub>CL</sub> = 100 μA; t <sub>p</sub> = 1 ms; T <sub>j</sub> ≤ 125 °C; see <u>Figure 13</u>	650	-	-	V



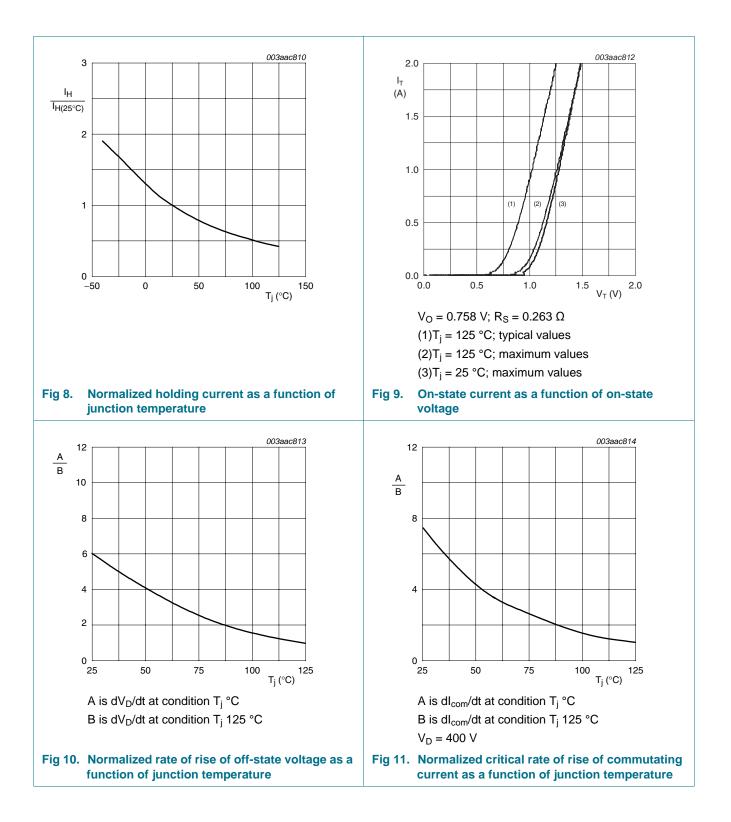


junction temperature

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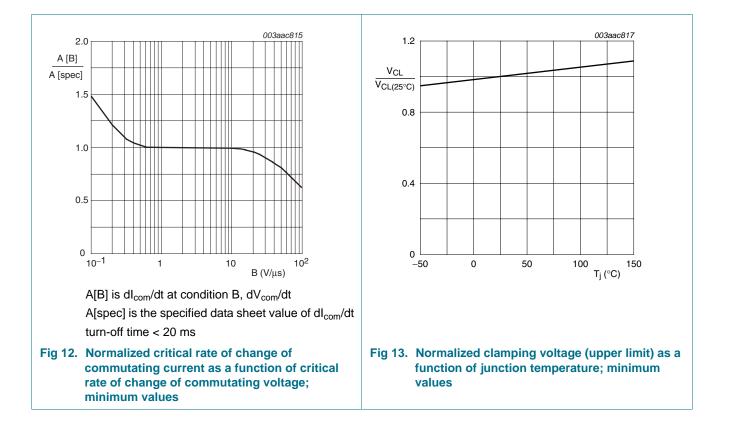
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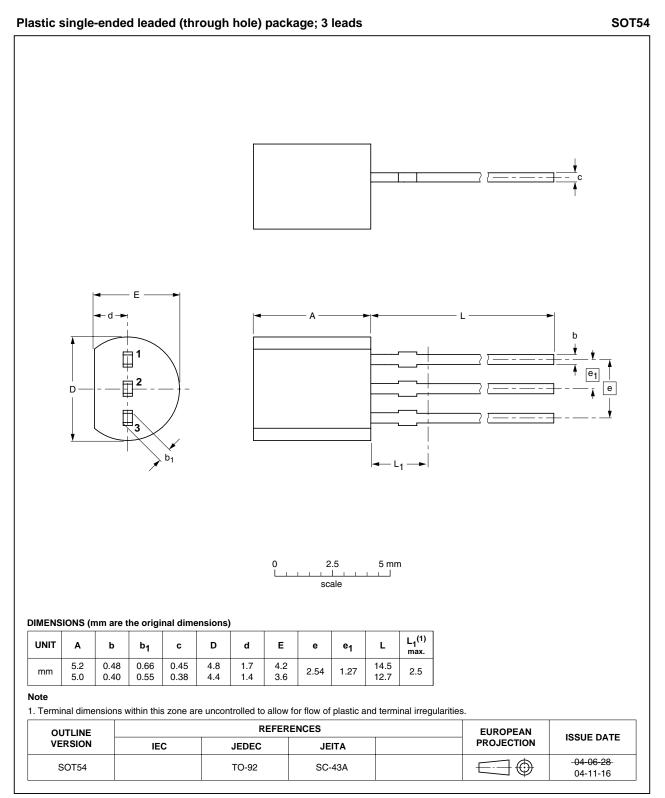
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### 7. Package outline



#### Fig 14. Package outline SOT54 (TO-92)

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ACT108-600E



# 8. Revision history

Table 7.   Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
ACT108-600E v.3	20100713	Product data sheet	-	ACT108-600E v.2		
Modifications:	<ul> <li>Various change</li> </ul>	es to content.				
ACT108-600E v.2	20091021	Product data sheet	-	-		

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### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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